

03-16-2000



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To the Honorable Commissioner of Patents and Trademarks, please forward the attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Sywe N. LEE  
David WAYNE

## 2. Name and address of receiving party(ies):

Name: TAIWAN ADVANCED SENSORS CORPORATIONAddress: 4F., No. 75, Sec. 1, Hsin Tai Wu Road,Hsi-ChihCity: Taipei HsienState/Prov.: JC625 U.S. PTOCountry: TAIWANZIP: 09/497051

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

## 3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: January 21, 2000

Additional name(s) &amp; address(es)

☐ Yes☒ No

## 4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: January 21, 2000

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☐ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Robert Berliner, Esq.Registration No. 20,121Address: FULBRIGHT & JAWORSKI L.L.P.865 South Figueroa Street29th FloorCity: Los AngelesState/Prov.: CACountry: United StatesZIP: 90017-2576

## 6. Total number of applications and patents involved:

17. Total fee (37 CFR 3.41):.....\$ 40.00☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

## 8. Deposit account number:

50-0337

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## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert Berliner, Esq.

Name of Person Signing

Signature

February 2, 2000

Date

Total number of pages including cover sheet, attachments, and

3

PATENT

REEL: 010601 FRAME: 0957

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

## WHEREAS,

inventor(s) ► 1. Sywe N. Lee residing at 4F., No. 75, Sec. 1, Hsin Tai Wu Road,  
 Name. Hsi-Chih, Taipei Hsien, Taiwan, R.O.C.  
 Address. \_\_\_\_\_ and a citizen of U.S.A.  
 Citizenship \_\_\_\_\_

2. David Wayne residing at 17350 N. Hartford Drive,  
Scottsdale, AZ 85255, U.S.A.  
 \_\_\_\_\_ and a citizen of U.S.A.  
 3. \_\_\_\_\_ residing at \_\_\_\_\_  
 \_\_\_\_\_ and a citizen of \_\_\_\_\_

Date Patent Declaration Signed and Title ► (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on \_\_\_\_\_ for this invention, which application is entitled INTERLACED \* PIXEL DESIGN FOR HIGH SENSITIVITY CMOS IMAGE  
SENSORS \*ALTERNATING and which has been given

Serial No. and Filing Date ► Serial Number \_\_\_\_\_ and the filing date of \_\_\_\_\_

Name of Corporation ► AND WHEREAS Taiwan Advanced Sensors Corporation (herein called "ASSIGNEE"), a corporation organized under the laws of R.O.C., and having an office and place of business at 4F., No. 75, Sec. 1, Hsin Tai Wu Road, Hsi-Chih, Taipei Hsien, Taiwan, R.O.C.

State or Country of Incorporation and Address ► wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

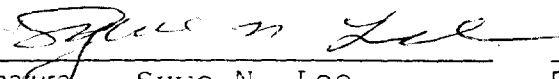
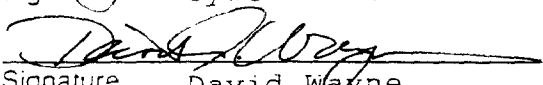
NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each Inventor  
Must Sign  
and Date

	<u>21 January 2000</u>
Signature <u>Sywe N. Lee</u>	Date _____
	<u>21 January 2000</u>
Signature <u>David Wayne</u>	Date _____
Signature _____	Date _____

Note: No  
Legalization or  
Other Witness  
Required